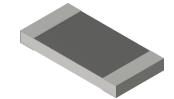
Resistive Product Solutions

Features:

- Molded package for superior heat dissipation
- Typical inductance < 5nH
- RoHS compliant, REACH compliant, lead free, and halogen free
- Package size 2512 is AEC-Q200 compliant



Electrical Specifications							
Type/Code Power Rating (W) TCR (ppm/ ⁰ C) Ohmic Range (Ω) and Tolerance 1%, 5%							
CSM0603	0.33	± 70	0.01				
CSM2512	3	± 50	0.001 - 0.1				

Max. Working Voltage = $(P^*R)^{1/2}$

P = Rated Power (W)

R = Resistance Value (Ω)

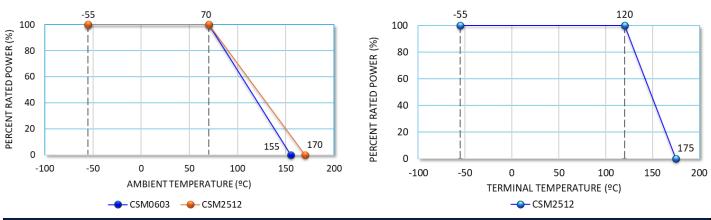
	Mechanical Specifications							
L W								
	$ \begin{array}{c c} \hline \\ \hline \\$							
Type/Code	L	W	Н	d	Unit			
CSM0603	0.063 ± 0.004 1.60 ± 0.10	0.031 ± 0.004 0.80 ± 0.10	0.012 ± 0.004 0.30 ± 0.10	0.012 ± 0.004 0.30 ± 0.10	inches mm			
$ \begin{array}{c c} CSM2512 \\ (0.001 \ \Omega \ - \ 0.004 \ \Omega) \end{array} & \begin{array}{c} 0.252 \ \pm \ 0.008 \\ 6.40 \ \pm \ 0.20 \end{array} & \begin{array}{c} 0.126 \ \pm \ 0.008 \\ 3.20 \ \pm \ 0.20 \end{array} & \begin{array}{c} 0.035 \ \pm \ 0.008 \\ 0.90 \ \pm \ 0.20 \end{array} & \begin{array}{c} 0.079 \ \pm \ 0.008 \\ 2.00 \ \pm \ 0.20 \end{array} & \begin{array}{c} \text{inches} \\ \text{mm} \end{array} \\ \end{array} $								
CSM2512 (> 0.004 Ω - 0.1 Ω)	0.252 ± 0.008 6.40 ± 0.20	0.126 ± 0.008 3.20 ± 0.20	0.035 ± 0.008 0.90 ± 0.20	0.035 ± 0.008 0.90 ± 0.20	inches mm			

Performance Characteristics							
Test Item	Test Specification	Test Condition					
Temperature Coefficient of Resistance	CSM2512 ± 50 ppm/⁰C CSM0603 ± 70 ppm/⁰C	+25 ~ +125°C					
Load Life	± 1%	1000 hours at rated power, 70°C, 1.5 hours ON, 0.5 hours OFF					
Short Time Overload	± 0.5%	5 X rated power for 5 seconds					
Moisture No Load	± 0.5%	85ºC, 85% R.H., 1000 hours					
Temperature Cycling	< ± 0.5%	1000 cycles (-55 to 125°C) Measurement at 24 hours after test conclusio JESD22 Method JA-104					
Resistance to Soldering Heat	± 0.5%	260 ± 5°C for 20 ± 1 seconds					
Solderability	At least 95% of surface area of electrode must be covered with new solder	$245 \pm 5^{\circ}$ C for 2 ± 0.5 seconds					
High Temperature Exposure	± 0.5%	170°C for 1000 hours					
Low Temperature Storage	± 0.5%	-55°C for 1000 hours					
Substrate Bending	± 1%	Bending width 2 mm					
Insulation Resistance	> 100MΩ	100VDC for 1 minute					

Recommended storage conditions: Temperature 5 ~ 35° C; R.H. 40% ~ 75% Operating temperature range for CSM0603 is -55 to +155°C and for CSM2512 is -55 to +170°C

Resistive Product Solutions

Power Derating Curve:



Recommended Pad Layout								
Cu Trace								
Type/Code	а	b	L	Unit				
CSM0603	0.039 1.00	0.028 0.70	0.035 0.90	inches mm				
CSM2512 (≤ 0.004 Ω)	0.157 4.00	0.122 3.10	0.051 1.30	inches mm				
CSM2512 (> 0.004 Ω)	0.157 4.00	0.083 2.10	0.161 4.10	inches mm				

Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

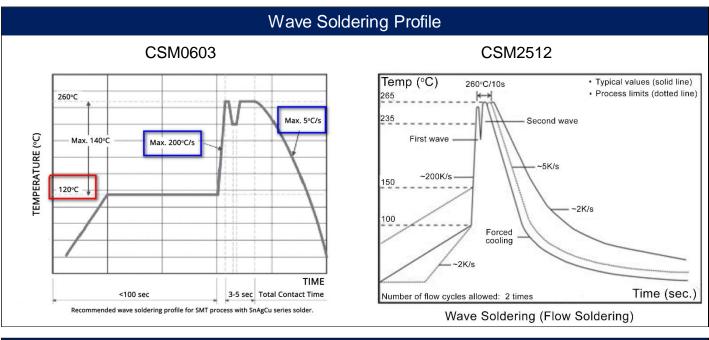
Wave Soldering								
Description Maximum Recommended Minimum								
Preheat Time	80 seconds	70 seconds	60 seconds					
Temperature Diff. 140°C 120°C 100°C								
Solder Temp. 260°C 250°C 240°C								
Dwell Time at Max. 10 seconds 5 seconds *								
Ramp DN (°C/sec)	N/A	N/A	N/A					

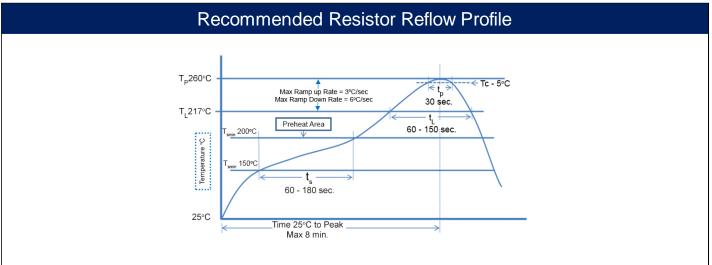
Temperature Diff. = Difference between final preheat stage and soldering stage.

Stackpole Electronics, Inc.

Resistive Product Solutions

Convection IR Reflow									
Description	Description Maximum Recommended Minimum								
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*						
Dwell Time > 217°C	90 seconds	60 seconds							
Solder Temp.	260°C	245°C	*						
Dwell Time at Max.	30 seconds	15 seconds	10 seconds						
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*						





Molded Metal Alloy Current Sensing Resistor

Reel Specifications							
Type/Code	A	В	С	D	Unit		
CSM0603 7.087 ± 0.059 180.00 ± 1.50 2.362 ± 0.039 60.00 ± 1.00 0.512 ± 0.008 13.00 ± 0.20 0.354 + 0.039 9.00 + 1.00 inches mm							
CSM2512	7.087 ± 0.059 180.00 ± 1.50	2.362 ± 0.039 60.00 ± 1.00	0.512 ± 0.039 13.00 ± 1.00	0.512 + 0.039 13.00 + 1.00	inches mm		

Taping Specifications - Paper Tape								
Type/Code	А	В	W	F		E	Unit	
	0.075 ± 0.008 0.045 ± 0.006 0.315 ± 0.008 0.138 ± 0.002 0.069 ± 0.004 inches 1.90 ± 0.20 1.15 ± 0.15 8.00 ± 0.20 3.50 ± 0.05 1.75 ± 0.10 mm							
CSM0603	CSM0603 P1 P0 ØD T Unit							

Taping Specifications - Plastic Tape								
Top Tape ϕ D ₀ ϕ D ₀ ϕ D ₁ 1.5 min. Emboss Tape direction of unreeling								
Type/Code	А	В	W	F	E	Unit		
	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$							
CSM2512	CSM2512 P1 P2 P0 D0 t Unit							
	0.157 ± 0.004 4.00 ± 0.10	0.079 ± 0.002 2.00 ± 0.05	0.157 ± 0.002 4.00 ± 0.05	0.059 +0.004 / -0 1.50 +0.10 / -0	0.047 ± 0.006 1.20 ± 0.15	inches mm		

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

	RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)			
CSM	Molded Metal Alloy Current Sensing Resistor	SMD	YES	100% Matte Sn over Ni	Always	Always			

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

